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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	17280
Total RAM Bits	442368
Number of I/O	333
Number of Gates	1000000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s1000-5fg456c

Supply Voltages for the IOBs

Three different supplies power the IOBs:

- The V_{CCO} supplies, one for each of the FPGA's I/O banks, power the output drivers, except when using the GTL and GTLP signal standards. The voltage on the V_{CCO} pins determines the voltage swing of the output signal.
- V_{CCINT} is the main power supply for the FPGA's internal logic.
- The V_{CCAUX} is an auxiliary source of power, primarily to optimize the performance of various FPGA functions such as I/O switching.

The I/Os During Power-On, Configuration, and User Mode

With no power applied to the FPGA, all I/Os are in a high-impedance state. The V_{CCINT} (1.2V), V_{CCAUX} (2.5V), and V_{CCO} supplies may be applied in any order. Before power-on can finish, V_{CCINT} , V_{CCO} Bank 4, and V_{CCAUX} must have reached their respective minimum recommended operating levels (see [Table 29, page 59](#)). At this time, all I/O drivers also will be in a high-impedance state. V_{CCO} Bank 4, V_{CCINT} , and V_{CCAUX} serve as inputs to the internal Power-On Reset circuit (POR).

A Low level applied to the HSWAP_EN input enables pull-up resistors on User I/Os from power-on throughout configuration. A High level on HSWAP_EN disables the pull-up resistors, allowing the I/Os to float. If the HSWAP_EN pin is floating, then an internal pull-up resistor pulls HSWAP_EN High. As soon as power is applied, the FPGA begins initializing its configuration memory. At the same time, the FPGA internally asserts the Global Set-Reset (GSR), which asynchronously resets all IOB storage elements to a Low state.

Upon the completion of initialization, INIT_B goes High, sampling the M0, M1, and M2 inputs to determine the configuration mode. At this point, the configuration data is loaded into the FPGA. The I/O drivers remain in a high-impedance state (with or without pull-up resistors, as determined by the HSWAP_EN input) throughout configuration.

The Global Three State (GTS) net is released during Start-Up, marking the end of configuration and the beginning of design operation in the User mode. At this point, those I/Os to which signals have been assigned go active while all unused I/Os remain in a high-impedance state. The release of the GSR net, also part of Start-up, leaves the IOB registers in a Low state by default, unless the loaded design reverses the polarity of their respective RS inputs.

In User mode, all internal pull-up resistors on the I/Os are disabled and HSWAP_EN becomes a “don't care” input. If it is desirable to have pull-up or pull-down resistors on I/Os carrying signals, the appropriate symbol—e.g., PULLUP, PULLDOWN—must be placed at the appropriate pads in the design. The Bitstream Generator (Bitgen) option UnusedPin available in the Xilinx development software determines whether unused I/Os collectively have pull-up resistors, pull-down resistors, or no resistors in User mode.

CLB Overview

For more details on the CLBs, refer to the chapter entitled “Using Configurable Logic Blocks” in [UG331](#).

The Configurable Logic Blocks (CLBs) constitute the main logic resource for implementing synchronous as well as combinatorial circuits. Each CLB comprises four interconnected slices, as shown in [Figure 11](#). These slices are grouped in pairs. Each pair is organized as a column with an independent carry chain.

The nomenclature that the FPGA Editor—part of the Xilinx development software—uses to designate slices is as follows: The letter ‘X’ followed by a number identifies columns of slices. The ‘X’ number counts up in sequence from the left side of the die to the right. The letter ‘Y’ followed by a number identifies the position of each slice in a pair as well as indicating the CLB row. The ‘Y’ number counts slices starting from the bottom of the die according to the sequence: 0, 1, 0, 1 (the first CLB row); 2, 3, 2, 3 (the second CLB row); etc. [Figure 11](#) shows the CLB located in the lower left-hand corner of the die. Slices X0Y0 and X0Y1 make up the column-pair on the left where as slices X1Y0 and X1Y1 make up the column-pair on the right. For each CLB, the term “left-hand” (or SLICEM) indicates the pair of slices labeled with an even ‘X’ number, such as X0, and the term “right-hand” (or SLICEL) designates the pair of slices with an odd ‘X’ number, e.g., X1.

Function Generator

Each of the two LUTs (F and G) in a slice have four logic inputs (A1-A4) and a single output (D). This permits any four-variable Boolean logic operation to be programmed into them. Furthermore, wide function multiplexers can be used to effectively combine LUTs within the same CLB or across different CLBs, making logic functions with still more input variables possible.

The LUTs in both the right-hand and left-hand slice-pairs not only support the logic functions described above, but also can function as ROM that is initialized with data at the time of configuration.

The LUTs in the left-hand slice-pair (even-numbered columns such as X0 in [Figure 11](#)) of each CLB support two additional functions that the right-hand slice-pair (odd-numbered columns such as X1) do not.

First, it is possible to program the “left-hand LUTs” as distributed RAM. This type of memory affords moderate amounts of data buffering anywhere along a data path. One left-hand LUT stores 16 bits. Multiple left-hand LUTs can be combined in various ways to store larger amounts of data. A dual port option combines two LUTs so that memory access is possible from two independent data lines. A Distributed ROM option permits pre-loading the memory with data during FPGA configuration.

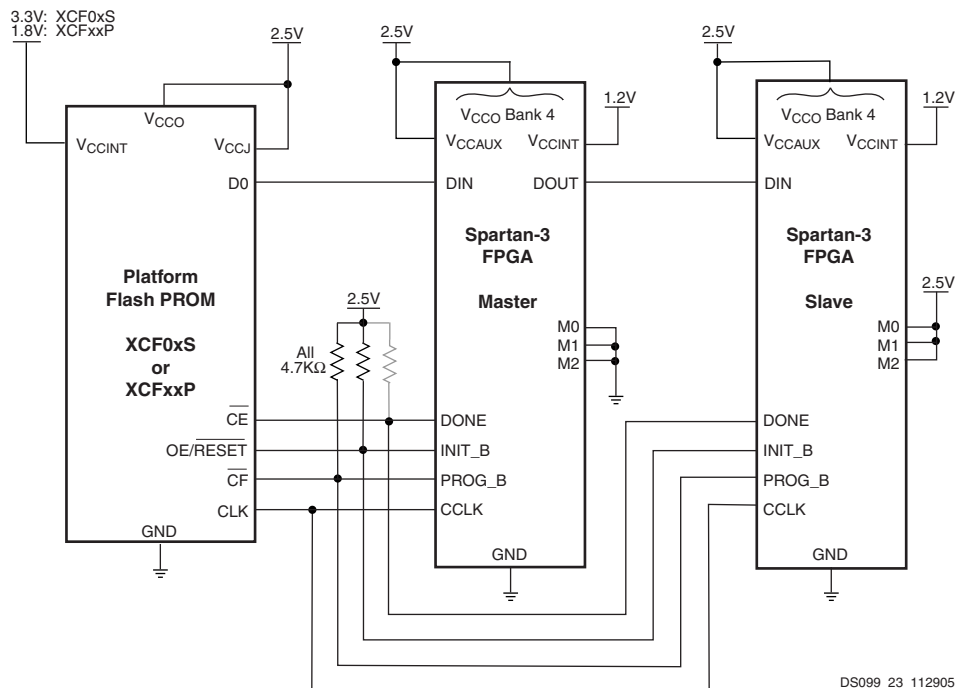
Second, it is possible to program each left-hand LUT as a 16-bit shift register. Used in this way, each LUT can delay serial data anywhere from one to 16 clock cycles. The four left-hand LUTs of a single CLB can be combined to produce delays up to 64 clock cycles. The SHIFTIN and SHIFTOUT lines cascade LUTs to form larger shift registers. It is also possible to combine shift registers across more than one CLB. The resulting programmable delays can be used to balance the timing of data pipelines.

Block RAM Overview

All Spartan-3 devices support block RAM, which is organized as configurable, synchronous 18Kbit blocks. Block RAM stores relatively large amounts of data more efficiently than the distributed RAM feature described earlier. (The latter is better suited for buffering small amounts of data anywhere along signal paths.) This section describes basic Block RAM functions. For more information, refer to the chapter entitled “Using Block RAM” in [UG331](#).

The aspect ratio—i.e., width vs. depth—of each block RAM is configurable. Furthermore, multiple blocks can be cascaded to create still wider and/or deeper memories.

A choice among primitives determines whether the block RAM functions as dual- or single-port memory. A name of the form RAMB16_S[w_A][w_B] calls out the dual-port primitive, where the integers w_A and w_B specify the total data path width at ports w_A and w_B, respectively. Thus, a RAMB16_S9_S18 is a dual-port RAM with a 9-bit-wide Port A and an 18-bit-wide Port B. A name of the form RAMB16_S[w] identifies the single-port primitive, where the integer w specifies the total data path width of the lone port. A RAMB16_S18 is a single-port RAM with an 18-bit-wide port. Other memory functions—e.g., FIFOs, data path width conversion, ROM, etc.—are readily available using the CORE Generator™ software, part of the Xilinx development software.



Notes:

- There are two ways to use the DONE line. First, one may set the BitGen option DriveDone to "Yes" only for the last FPGA to be configured in the chain shown above (or for the single FPGA as may be the case). This enables the DONE pin to drive High; thus, no pull-up resistor is necessary. DriveDone is set to "No" for the remaining FPGAs in the chain. Second, DriveDone can be set to "No" for all FPGAs. Then all DONE lines are open-drain and require the pull-up resistor shown in grey. In most cases, a value between 3.3KΩ to 4.7KΩ is sufficient. However, when using DONE synchronously with a long chain of FPGAs, cumulative capacitance may necessitate lower resistor values (e.g. down to 330Ω) in order to ensure a rise time within one clock cycle.
- For information on how to program the FPGA using 3.3V signals and power, see [3.3V-Tolerant Configuration Interface](#).

Figure 26: Connection Diagram for Master and Slave Serial Configuration

Slave Serial mode is selected by applying <111> to the mode pins (M0, M1, and M2). A pull-up on the mode pins makes slave serial the default mode if the pins are left unconnected.

Master Serial Mode

In Master Serial mode, the FPGA drives CCLK pin, which behaves as a bidirectional I/O pin. The FPGA in the center of [Figure 26](#) is set for Master Serial mode and connects to the serial configuration PROM and to the CCLK inputs of any slave FPGAs in a configuration daisy-chain. The master FPGA drives the configuration clock on the CCLK pin to the Xilinx Serial PROM, which, in response, provides bit-serial data to the FPGA's DIN input. The FPGA accepts this data on each rising CCLK edge. After the master FPGA finishes configuring, it passes data on its DOUT pin to the next FPGA device in a daisy-chain. The DOUT data appears after the falling CCLK clock edge.

The Master Serial mode interface is identical to Slave Serial except that an internal oscillator generates the configuration clock (CCLK). A wide range of frequencies can be selected for CCLK, which always starts at a default frequency of 6 MHz. Configuration bits then switch CCLK to a higher frequency for the remainder of the configuration.

Slave Parallel Mode (SelectMAP)

The Parallel or SelectMAP modes support the fastest configuration. Byte-wide data is written into the FPGA with a BUSY flag controlling the flow of data. An external source provides 8-bit-wide data, CCLK, an active-Low Chip Select (CS_B) signal and an active-Low Write signal (RDWR_B). If BUSY is asserted (High) by the FPGA, the data must be held until BUSY goes Low. Data can also be read using the Slave Parallel mode. If RDWR_B is asserted, configuration data is read out of the FPGA as part of a readback operation.

After configuration, it is possible to use any of the Multipurpose pins (DIN/D0-D7, DOUT/BUSY, INIT_B, CS_B, and RDWR_B) as User I/Os. To do this, simply set the BitGen option *Persist* to *No* and assign the desired signals to multipurpose configuration pins using the Xilinx development software. Alternatively, it is possible to continue using the configuration port

Initial Spartan-3 FPGA mask revisions have a limit on how fast the V_{CCO} supply can ramp. The minimum allowed V_{CCO} ramp rate appears as T_{CCO} in [Table 30, page 60](#). The minimum rate is affected by the package inductance. Consequently, the ball grid array and chip-scale packages (CP132, FT256, FG456, FG676, and FG900) allow a faster ramp rate than the quad-flat packages (VQ100, TQ144, and PQ208).

Configuration Data Retention, Brown-Out

The FPGA's configuration data is stored in robust CMOS configuration latches. The data in these latches is retained even when the voltages drop to the minimum levels necessary to preserve RAM contents. This is specified in [Table 31, page 60](#).

If, after configuration, the V_{CCAUX} or V_{CCINT} supply drops below its data retention voltage, clear the current device configuration using one of the following methods:

- Force the V_{CCAUX} or V_{CCINT} supply voltage below the minimum Power On Reset (POR) voltage threshold [Table 29, page 59](#)).
- Assert PROG_B Low.

The POR circuit does not monitor the VCCO_4 supply after configuration. Consequently, dropping the VCCO_4 voltage does not reset the device by triggering a Power-On Reset (POR) event.

No Internal Charge Pumps or Free-Running Oscillators

Some system applications are sensitive to sources of analog noise. Spartan-3 FPGA circuitry is fully static and does not employ internal charge pumps.

The CCLK configuration clock is active during the FPGA configuration process. After configuration completes, the CCLK oscillator is automatically disabled unless the Bitstream Generator (BitGen) option **Persist=Yes**. See Module 4: [Table 80, page 125](#).

Spartan-3 FPGAs optionally support a feature called [Digitally Controlled Impedance \(DCI\)](#). When used in an application, the DCI logic uses an internal oscillator. The DCI logic is only enabled if the FPGA application specifies an I/O standard that requires DCI (LVDCI_33, LVDCI_25, etc.). If DCI is not used, the associated internal oscillator is also disabled.

In summary, unless an application uses the **Persist=Yes** option or specifies a DCI I/O standard, an FPGA with no external switching remains fully static.

Table 36: DC Characteristics of User I/Os Using Single-Ended Standards

Signal Standard (IOSTANDARD) and Current Drive Attribute (mA)		Test Conditions		Logic Level Characteristics	
		I _{OL} (mA)	I _{OH} (mA)	V _{OL} Max (V)	V _{OH} Min (V)
GTL		32	—	0.4	—
GTL_DCI		Note 3	Note 3		
GTLP		36	—	0.6	—
GTLP_DCI		Note 3	Note 3		
HSLVDCI_15		Note 3	Note 3	0.4	V _{CCO} – 0.4
HSLVDCI_18					
HSLVDCI_25					
HSLVDCI_33					
HSTL_I		8	–8	0.4	V _{CCO} – 0.4
HSTL_I_DCI		Note 3	Note 3		
HSTL_III		24	–8	0.4	V _{CCO} – 0.4
HSTL_III_DCI		Note 3	Note 3		
HSTL_I_18		8	–8	0.4	V _{CCO} – 0.4
HSTL_I_DCI_18		Note 3	Note 3		
HSTL_II_18		16	–16	0.4	V _{CCO} – 0.4
HSTL_II_DCI_18		Note 3	Note 3		
HSTL_III_18		24	–8	0.4	V _{CCO} – 0.4
HSTL_III_DCI_18		Note 3	Note 3		
LVCMOS12 ⁽⁴⁾	2	2	–2	0.4	V _{CCO} – 0.4
	4	4	–4		
	6	6	–6		
LVCMOS15 ⁽⁴⁾	2	2	–2	0.4	V _{CCO} – 0.4
	4	4	–4		
	6	6	–6		
	8	8	–8		
	12	12	–12		
LVDCI_15, LVDCI_DV2_15		Note 3	Note 3		
LVCMOS18 ⁽⁴⁾	2	2	–2	0.4	V _{CCO} – 0.4
	4	4	–4		
	6	6	–6		
	8	8	–8		
	12	12	–12		
	16	16	–16		
LVDCI_18, LVDCI_DV2_18		Note 3	Note 3		
LVCMOS25 ^(4,5)	2	2	–2	0.4	V _{CCO} – 0.4
	4	4	–4		
	6	6	–6		
	8	8	–8		
	12	12	–12		
	16	16	–16		
	24	24	–24		
LVDCI_25, LVDCI_DV2_25		Note 3	Note 3		

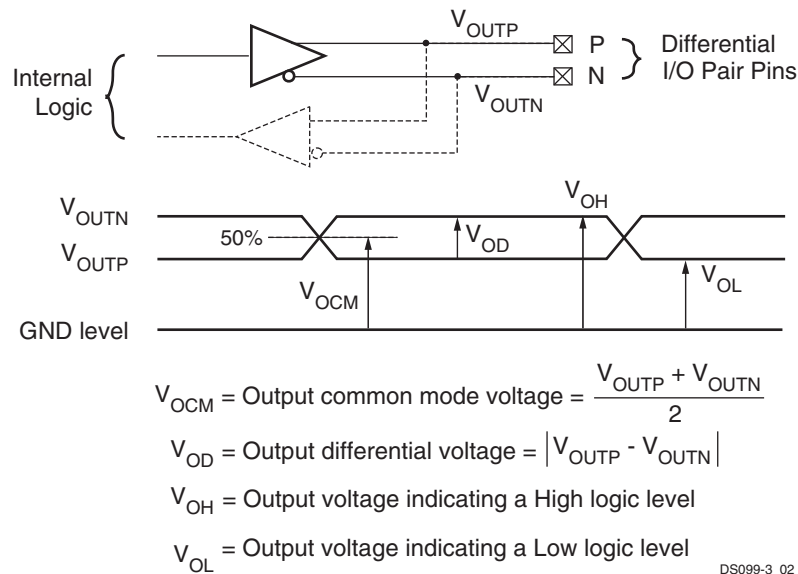


Figure 33: Differential Output Voltages

Table 38: DC Characteristics of User I/Os Using Differential Signal Standards

Signal Standard	Mask ⁽³⁾ Revision	V_{OD}			V_{OCM}			V_{OH}	V_{OL}
		Min (mV)	Typ (mV)	Max (mV)	Min (V)	Typ (V)	Max (V)	Min (V)	Max (V)
LDT_25 (ULVDS_25)	All	430 ⁽⁴⁾	600	670	0.495	0.600	0.715	0.71	0.50
LVDS_25	All	100	—	600	0.80	—	1.6	0.85	1.55
	'E'	200	—	500	1.0	—	1.5	1.10	1.40
BLVDS_25 ⁽⁵⁾	All	250	350	450	—	1.20	—	—	—
LVDSEXT_25	All	100	—	600	0.80	—	1.6	0.85	1.55
	'E'	300	—	700	1.0	—	1.5	1.15	1.35
LVPECL_25 ⁽⁵⁾	All	—	—	—	—	—	—	1.35	1.005
RSDS_25 ⁽⁶⁾	All	100	—	600	0.80	—	1.6	0.85	1.55
	'E'	200	—	500	1.0	—	1.5	1.10	1.40
DIFF_HSTL_II_18	All	—	—	—	—	—	—	$V_{CCO} - 0.40$	0.40
DIFF_SSTL2_II	All	—	—	—	—	—	—	$V_{TT} + 0.80$	$V_{TT} - 0.80$

Notes:

- The numbers in this table are based on the conditions set forth in Table 32 and Table 37.
- Output voltage measurements for all differential standards are made with a termination resistor (R_T) of 100 Ω across the N and P pins of the differential signal pair.
- Mask revision E devices have tighter output ranges but can be used in any design that was in a previous revision. See Mask and Fab Revisions, page 58.
- This value must be compatible with the receiver to which the FPGA's output pair is connected.
- Each LVPECL_25 or BLVDS_25 output-pair requires three external resistors for proper output operation as shown in Figure 34. Each LVPECL_25 or BLVDS_25 input-pair uses a 100 Ω termination resistor at the receiver.
- Only one of the differential standards RSDS_25, LDT_25, LVDS_25, and LVDSEXT_25 may be used for outputs within a bank. Each differential standard input-pair requires an external 100 Ω termination resistor.

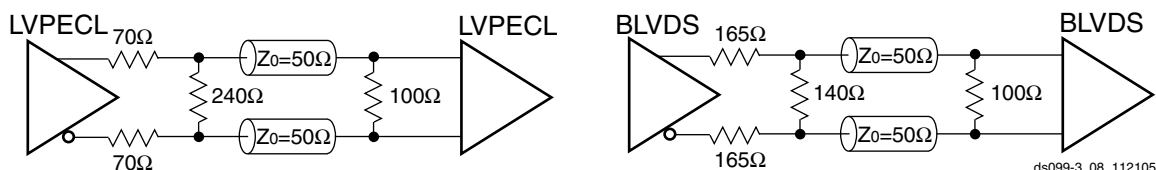


Figure 34: External Termination Required for LVPECL and BLVDS Output and Input

Table 44: Input Timing Adjustments for IOB (Cont'd)

Convert Input Time from LVCMOS25 to the Following Signal Standard (IOSTANDARD)	Add the Adjustment Below		Units
	Speed Grade		
	-5	-4	
LVCMOS15	0.42	0.49	ns
LVDCI_15	0.38	0.43	ns
LVDCI_DV2_15	0.38	0.44	ns
LVCMOS18	0.24	0.28	ns
LVDCI_18	0.29	0.33	ns
LVDCI_DV2_18	0.28	0.33	ns
LVCMOS25	0	0	ns
LVDCI_25	0.05	0.05	ns
LVDCI_DV2_25	0.04	0.04	ns
LVCMOS33, LVDCI_33, LVDCI_DV2_33	−0.05	−0.02	ns
LVTTTL	0.18	0.21	ns
PCI33_3	0.20	0.22	ns
SSTL18_I, SSTL18_I_DCI	0.39	0.45	ns
SSTL18_II	0.39	0.45	ns
SSTL2_I, SSTL2_I_DCI	0.40	0.46	ns
SSTL2_II, SSTL2_II_DCI	0.36	0.41	ns
Differential Standards			
LDT_25 (ULVDS_25)	0.76	0.88	ns
LVDS_25, LVDS_25_DCI	0.65	0.75	ns
BLVDS_25	0.34	0.39	ns
LVDSEXT_25, LVDSEXT_25_DCI	0.80	0.92	ns
LVPECL_25	0.18	0.21	ns
RSDS_25	0.43	0.50	ns
DIFF_HSTL_II_18, DIFF_HSTL_II_18_DCI	0.34	0.39	ns
DIFF_SSTL2_II, DIFF_SSTL2_II_DCI	0.65	0.75	ns

Notes:

1. The numbers in this table are tested using the methodology presented in [Table 48](#) and are based on the operating conditions set forth in [Table 32](#), [Table 35](#), and [Table 37](#).
2. These adjustments are used to convert input path times originally specified for the LVCMOS25 standard to times that correspond to other signal standards.

Internal Logic Timing

Table 51: CLB Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T _{CKO}	When reading from the FFX (FFY) Flip-Flop, the time from the active transition at the CLK input to data appearing at the XQ (YQ) output	—	0.63	—	0.72	ns
Setup Times						
T _{AS}	Time from the setup of data at the F or G input to the active transition at the CLK input of the CLB	0.46	—	0.53	—	ns
T _{DICK}	Time from the setup of data at the BX or BY input to the active transition at the CLK input of the CLB	1.27	—	1.57	—	ns
Hold Times						
T _{AH}	Time from the active transition at the CLK input to the point where data is last held at the F or G input	0	—	0	—	ns
T _{CKDI}	Time from the active transition at the CLK input to the point where data is last held at the BX or BY input	0.25	—	0.29	—	ns
Clock Timing						
T _{CH}	CLB CLK signal High pulse width	0.69	∞	0.79	∞	ns
T _{CL}	CLB CLK signal Low pulse width	0.69	∞	0.79	∞	ns
F _{TOG}	Maximum toggle frequency (for export control)	—	725	—	630	MHz
Propagation Times						
T _{ILO}	The time it takes for data to travel from the CLB's F (G) input to the X (Y) output	—	0.53	—	0.61	ns
Set/Reset Pulse Width						
T _{RPW_CLB}	The minimum allowable pulse width, High or Low, to the CLB's SR input	0.76	—	0.87	—	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in [Table 32](#).
2. The timing shown is for SLICEM.
3. For minimums, use the values reported by the Xilinx timing analyzer.

Mechanical Drawings

Detailed mechanical drawings for each package type are available from the Xilinx website at the specified location in [Table 83](#).

Material Declaration Data Sheets (MDDS) are also available on the [Xilinx website](#) for each package.

Table 83: Xilinx Package Mechanical Drawings

Package	Web Link (URL)
VQ100 and VQG100	http://www.xilinx.com/support/documentation/package_specs/vq100.pdf
CP132 and CPG132 ⁽¹⁾	http://www.xilinx.com/support/documentation/package_specs/cp132.pdf
TQ144 and TQG144	http://www.xilinx.com/support/documentation/package_specs/tq144.pdf
PQ208 and PQG208	http://www.xilinx.com/support/documentation/package_specs/pq208.pdf
FT256 and FTG256	http://www.xilinx.com/support/documentation/package_specs/ft256.pdf
FG320 and FGG320	http://www.xilinx.com/support/documentation/package_specs/fg320.pdf
FG456 and FGG456	http://www.xilinx.com/support/documentation/package_specs/fg456.pdf
FG676 and FGG676	http://www.xilinx.com/support/documentation/package_specs/fg676.pdf
FG900 and FGG900	http://www.xilinx.com/support/documentation/package_specs/fg900.pdf
FG1156 and FGG1156 ⁽¹⁾	http://www.xilinx.com/support/documentation/package_specs/fg1156.pdf

Notes:

1. The CP132, CPG132, FG1156, and FGG1156 packages are discontinued. See http://www.xilinx.com/support/documentation/spartan-3_customer_notices.htm.

Power, Ground, and I/O by Package

Each package has three separate voltage supply inputs—VCCINT, VCCAUX, and VCCO—and a common ground return, GND. The numbers of pins dedicated to these functions varies by package, as shown in [Table 84](#).

Table 84: Power and Ground Supply Pins by Package

Package	VCCINT	VCCAUX	VCCO	GND
VQ100	4	4	8	10
CP132 ⁽¹⁾	4	4	12	12
TQ144	4	4	12	16
PQ208	4	8	12	28
FT256	8	8	24	32
FG320	12	8	28	40
FG456	12	8	40	52
FG676	20	16	64	76
FG900	32	24	80	120
FG1156 ⁽¹⁾	40	32	104	184

Notes:

1. The CP132, CPG132, FG1156, and FGG1156 packages are discontinued. See http://www.xilinx.com/support/documentation/spartan-3_customer_notices.htm.

A majority of package pins are user-defined I/O pins. However, the numbers and characteristics of these I/O depends on the device type and the package in which it is available, as shown in [Table 85](#). The table shows the maximum number of single-ended I/O pins available, assuming that all I/O-, DUAL-, DCI-, VREF-, and GCLK-type pins are used as general-purpose I/O. Likewise, the table shows the maximum number of differential pin-pairs available on the package. Finally, the table shows how the total maximum user I/Os are distributed by pin type, including the number of unconnected—i.e., N.C.—pins on the device.

Table 91: TQ144 Package Pinout (Cont'd)

Bank	XC3S50, XC3S200, XC3S400 Pin Name	TQ144 Pin Number	Type
6,7	VCCO_LEFT	P34	VCCO
6,7	VCCO_LEFT	P3	VCCO
N/A	GND	P136	GND
N/A	GND	P139	GND
N/A	GND	P114	GND
N/A	GND	P117	GND
N/A	GND	P94	GND
N/A	GND	P101	GND
N/A	GND	P81	GND
N/A	GND	P88	GND
N/A	GND	P64	GND
N/A	GND	P67	GND
N/A	GND	P42	GND
N/A	GND	P45	GND
N/A	GND	P22	GND
N/A	GND	P29	GND
N/A	GND	P9	GND
N/A	GND	P16	GND
N/A	VCCAUX	P134	VCCAUX
N/A	VCCAUX	P120	VCCAUX
N/A	VCCAUX	P62	VCCAUX
N/A	VCCAUX	P48	VCCAUX
N/A	VCCINT	P133	VCCINT
N/A	VCCINT	P121	VCCINT
N/A	VCCINT	P61	VCCINT
N/A	VCCINT	P49	VCCINT
VCCAUX	CCLK	P72	CONFIG
VCCAUX	DONE	P71	CONFIG
VCCAUX	HSWAP_EN	P142	CONFIG
VCCAUX	M0	P38	CONFIG
VCCAUX	M1	P37	CONFIG
VCCAUX	M2	P39	CONFIG
VCCAUX	PROG_B	P143	CONFIG
VCCAUX	TCK	P110	JTAG
VCCAUX	TDI	P144	JTAG
VCCAUX	TDO	P109	JTAG
VCCAUX	TMS	P111	JTAG

Table 93: PQ208 Package Pinout (Cont'd)

Bank	XC3S50 Pin Name	XC3S200, XC3S400 Pin Names	PQ208 Pin Number	Type
7	IO_L21N_7	IO_L21N_7	P13	I/O
7	IO_L21P_7	IO_L21P_7	P12	I/O
7	IO_L22N_7	IO_L22N_7	P16	I/O
7	IO_L22P_7	IO_L22P_7	P15	I/O
7	IO_L23N_7	IO_L23N_7	P19	I/O
7	IO_L23P_7	IO_L23P_7	P18	I/O
7	IO_L24N_7	IO_L24N_7	P21	I/O
7	IO_L24P_7	IO_L24P_7	P20	I/O
7	N.C. (◆)	IO_L39N_7	P24	I/O
7	N.C. (◆)	IO_L39P_7	P22	I/O
7	IO_L40N_7/VREF_7	IO_L40N_7/VREF_7	P27	VREF
7	IO_L40P_7	IO_L40P_7	P26	I/O
7	VCCO_7	VCCO_7	P6	VCCO
7	VCCO_7	VCCO_7	P23	VCCO
N/A	GND	GND	P1	GND
N/A	GND	GND	P186	GND
N/A	GND	GND	P195	GND
N/A	GND	GND	P202	GND
N/A	GND	GND	P163	GND
N/A	GND	GND	P170	GND
N/A	GND	GND	P179	GND
N/A	GND	GND	P134	GND
N/A	GND	GND	P145	GND
N/A	GND	GND	P151	GND
N/A	GND	GND	P157	GND
N/A	GND	GND	P112	GND
N/A	GND	GND	P118	GND
N/A	GND	GND	P129	GND
N/A	GND	GND	P82	GND
N/A	GND	GND	P91	GND
N/A	GND	GND	P99	GND
N/A	GND	GND	P105	GND
N/A	GND	GND	P53	GND
N/A	GND	GND	P59	GND
N/A	GND	GND	P66	GND
N/A	GND	GND	P75	GND
N/A	GND	GND	P30	GND
N/A	GND	GND	P41	GND
N/A	GND	GND	P47	GND
N/A	GND	GND	P8	GND

Table 98: FG320 Package Pinout (Cont'd)

Bank	XC3S400, XC3S1000, XC3S1500 Pin Name	FG320 Pin Number	Type
N/A	VCCINT	N6	VCCINT
N/A	VCCINT	N7	VCCINT
VCCAUX	CCLK	T15	CONFIG
VCCAUX	DONE	R15	CONFIG
VCCAUX	HSWAP_EN	E6	CONFIG
VCCAUX	M0	P5	CONFIG
VCCAUX	M1	U3	CONFIG
VCCAUX	M2	R4	CONFIG
VCCAUX	PROG_B	E5	CONFIG
VCCAUX	TCK	E14	JTAG
VCCAUX	TDI	D4	JTAG
VCCAUX	TDO	D15	JTAG
VCCAUX	TMS	B16	JTAG

User I/Os by Bank

Table 99 indicates how the available user-I/O pins are distributed between the eight I/O banks on the FG320 package.

Table 99: User I/Os Per Bank in FG320 Package

Package Edge	I/O Bank	Maximum I/O	Maximum LVDS Pairs	All Possible I/O Pins by Type				
				I/O	DUAL	DCI	VREF	GCLK
Top	0	26	11	19	0	2	3	2
	1	26	11	19	0	2	3	2
Right	2	29	14	23	0	2	4	0
	3	29	14	23	0	2	4	0
Bottom	4	27	11	13	6	2	4	2
	5	26	11	13	6	2	3	2
Left	6	29	14	23	0	2	4	0
	7	29	14	23	0	2	4	0

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	H9	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	H10	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	J11	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	J12	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	J13	VCCO
0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	VCCO_0	K13	VCCO
1	IO	IO	IO	IO	IO	A14	I/O
1	IO	IO	IO	IO	IO	A22	I/O
1	IO	IO	IO	IO	IO	A23	I/O
1	IO	IO	IO	IO	IO	D16	I/O
1	IO	IO	IO	IO	IO_L17P_1 ⁽³⁾	E18	I/O
1	IO	IO	IO	IO	IO	F14	I/O
1	IO	IO	IO	IO	IO	F20	I/O
1	IO	IO	IO	IO	IO	G19	I/O
1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	C15	VREF
1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO/VREF_1	C17	VREF
1	N.C. (◆)	IO/VREF_1	IO/VREF_1	IO/VREF_1	IO_L17N_1/VREF_1 ⁽³⁾	D18	VREF
1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	D22	DCI
1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	E22	DCI
1	IO_L04N_1	IO_L04N_1	IO_L04N_1	IO_L04N_1	IO_L04N_1	B23	I/O
1	IO_L04P_1	IO_L04P_1	IO_L04P_1	IO_L04P_1	IO_L04P_1	C23	I/O
1	IO_L05N_1	IO_L05N_1	IO_L05N_1	IO_L05N_1	IO_L05N_1	E21	I/O
1	IO_L05P_1	IO_L05P_1	IO_L05P_1	IO_L05P_1	IO_L05P_1	F21	I/O
1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	B22	VREF
1	IO_L06P_1	IO_L06P_1	IO_L06P_1	IO_L06P_1	IO_L06P_1	C22	I/O
1	IO_L07N_1	IO_L07N_1	IO_L07N_1	IO_L07N_1	IO_L07N_1	C21	I/O
1	IO_L07P_1	IO_L07P_1	IO_L07P_1	IO_L07P_1	IO_L07P_1	D21	I/O
1	IO_L08N_1	IO_L08N_1	IO_L08N_1	IO_L08N_1	IO_L08N_1	A21	I/O
1	IO_L08P_1	IO_L08P_1	IO_L08P_1	IO_L08P_1	IO_L08P_1	B21	I/O
1	IO_L09N_1	IO_L09N_1	IO_L09N_1	IO_L09N_1	IO_L09N_1	D20	I/O
1	IO_L09P_1	IO_L09P_1	IO_L09P_1	IO_L09P_1	IO_L09P_1	E20	I/O
1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	A20	VREF
1	IO_L10P_1	IO_L10P_1	IO_L10P_1	IO_L10P_1	IO_L10P_1	B20	I/O
1	N.C. (◆)	IO_L11N_1	IO_L11N_1	IO_L11N_1	IO_L11N_1	E19	I/O
1	N.C. (◆)	IO_L11P_1	IO_L11P_1	IO_L11P_1	IO_L11P_1	F19	I/O
1	N.C. (◆)	IO_L12N_1	IO_L12N_1	IO_L12N_1	IO_L12N_1	C19	I/O
1	N.C. (◆)	IO_L12P_1	IO_L12P_1	IO_L12P_1	IO_L12P_1	D19	I/O
1	IO_L15N_1	IO_L15N_1	IO_L15N_1	IO_L15N_1	IO_L15N_1	A19	I/O
1	IO_L15P_1	IO_L15P_1	IO_L15P_1	IO_L15P_1	IO_L15P_1	B19	I/O
1	IO_L16N_1	IO_L16N_1	IO_L16N_1	IO_L16N_1	IO_L16N_1	F18	I/O
1	IO_L16P_1	IO_L16P_1	IO_L16P_1	IO_L16P_1	IO_L16P_1	G18	I/O
1	N.C. (◆)	IO_L18N_1	IO_L18N_1	IO_L18N_1	IO ⁽³⁾	B18	I/O

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
6	IO_L20N_6	IO_L20N_6	IO_L20N_6	IO_L20N_6	IO_L20N_6	V7	I/O
6	IO_L20P_6	IO_L20P_6	IO_L20P_6	IO_L20P_6	IO_L20P_6	U7	I/O
6	IO_L21N_6	IO_L21N_6	IO_L21N_6	IO_L21N_6	IO_L21N_6	V5	I/O
6	IO_L21P_6	IO_L21P_6	IO_L21P_6	IO_L21P_6	IO_L21P_6	V4	I/O
6	IO_L22N_6	IO_L22N_6	IO_L22N_6	IO_L22N_6	IO_L22N_6	V3	I/O
6	IO_L22P_6	IO_L22P_6	IO_L22P_6	IO_L22P_6	IO_L22P_6	V2	I/O
6	IO_L23N_6	IO_L23N_6	IO_L23N_6	IO_L23N_6	IO_L23N_6	U6	I/O
6	IO_L23P_6	IO_L23P_6	IO_L23P_6	IO_L23P_6	IO_L23P_6	U5	I/O
6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	U4	VREF
6	IO_L24P_6	IO_L24P_6	IO_L24P_6	IO_L24P_6	IO_L24P_6	U3	I/O
6	IO_L26N_6	IO_L26N_6	IO_L26N_6	IO_L26N_6	IO_L26N_6	U2	I/O
6	IO_L26P_6	IO_L26P_6	IO_L26P_6	IO_L26P_6	IO_L26P_6	U1	I/O
6	IO_L27N_6	IO_L27N_6	IO_L27N_6	IO_L27N_6	IO_L27N_6	T8	I/O
6	IO_L27P_6	IO_L27P_6	IO_L27P_6	IO_L27P_6	IO_L27P_6	T7	I/O
6	IO_L28N_6	IO_L28N_6	IO_L28N_6	IO_L28N_6	IO_L28N_6	T6	I/O
6	IO_L28P_6	IO_L28P_6	IO_L28P_6	IO_L28P_6	IO_L28P_6	T5	I/O
6	IO_L29N_6	IO_L29N_6	IO_L29N_6	IO_L29N_6	IO_L29N_6	T2	I/O
6	IO_L29P_6	IO_L29P_6	IO_L29P_6	IO_L29P_6	IO_L29P_6	T1	I/O
6	IO_L31N_6	IO_L31N_6	IO_L31N_6	IO_L31N_6	IO_L31N_6	R8	I/O
6	IO_L31P_6	IO_L31P_6	IO_L31P_6	IO_L31P_6	IO_L31P_6	R7	I/O
6	IO_L32N_6	IO_L32N_6	IO_L32N_6	IO_L32N_6	IO_L32N_6	R6	I/O
6	IO_L32P_6	IO_L32P_6	IO_L32P_6	IO_L32P_6	IO_L32P_6	R5	I/O
6	IO_L33N_6	IO_L33N_6	IO_L33N_6	IO_L33N_6	IO_L33N_6	T4	I/O
6	IO_L33P_6	IO_L33P_6	IO_L33P_6	IO_L33P_6	IO_L33P_6	R3	I/O
6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	R2	VREF
6	IO_L34P_6	IO_L34P_6	IO_L34P_6	IO_L34P_6	IO_L34P_6	R1	I/O
6	IO_L35N_6	IO_L35N_6	IO_L35N_6	IO_L35N_6	IO_L35N_6	P8	I/O
6	IO_L35P_6	IO_L35P_6	IO_L35P_6	IO_L35P_6	IO_L35P_6	P7	I/O
6	IO_L38N_6	IO_L38N_6	IO_L38N_6	IO_L38N_6	IO_L38N_6	P6	I/O
6	IO_L38P_6	IO_L38P_6	IO_L38P_6	IO_L38P_6	IO_L38P_6	P5	I/O
6	IO_L39N_6	IO_L39N_6	IO_L39N_6	IO_L39N_6	IO_L39N_6	P4	I/O
6	IO_L39P_6	IO_L39P_6	IO_L39P_6	IO_L39P_6	IO_L39P_6	P3	I/O
6	IO_L40N_6	IO_L40N_6	IO_L40N_6	IO_L40N_6	IO_L40N_6	P2	I/O
6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	P1	VREF
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	P9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	P10	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	R9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	T3	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	T9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	U8	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	V8	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	Y3	VCCO
7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	F5	DCI

User I/Os by Bank

Table 108 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S2000 in the FG900 package. Similarly, Table 109 shows how the available user-I/O pins are distributed between the eight I/O banks for the XC3S4000 and XC3S5000 in the FG900 package.

Table 108: User I/Os Per Bank for XC3S2000 in FG900 Package

Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	DUAL	DCI	VREF	GCLK
Top	0	71	62	0	2	5	2
	1	71	62	0	2	5	2
Right	2	69	61	0	2	6	0
	3	71	62	0	2	7	0
Bottom	4	72	57	6	2	5	2
	5	71	55	6	2	6	2
Left	6	69	60	0	2	7	0
	7	71	62	0	2	7	0

Table 109: User I/Os Per Bank for XC3S4000 and XC3S5000 in FG900 Package

Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	DUAL	DCI	VREF	GCLK
Top	0	79	70	0	2	5	2
	1	79	70	0	2	5	2
Right	2	79	71	0	2	6	0
	3	79	70	0	2	7	0
Bottom	4	80	65	6	2	5	2
	5	79	63	6	2	6	2
Left	6	79	70	0	2	7	0
	7	79	70	0	2	7	0

FG900 Footprint

Left Half of FG900 Package (Top View)

XC3S2000

(565 max. user I/O)

481 I/O: Unrestricted, general-purpose user I/O

48 VREF: User I/O or input voltage reference for bank

68 N.C.: Unconnected pins for XC3S2000 (◆)

XC3S4000, XC3S5000

(633 max user I/O)

549 I/O: Unrestricted, general-purpose user I/O

48 VREF: User I/O or input voltage reference for bank

0 N.C.: No unconnected pins in this package

All devices

12 DUAL: Configuration pin, then possible user I/O

8 GCLK: User I/O or global clock buffer input

16 DCI: User I/O or reference resistor input for bank

7 CONFIG: Dedicated configuration pins

4 JTAG: Dedicated JTAG port pins

32 VCCINT: Internal core voltage supply (+1.2V)

80 VCCO: Output voltage supply for bank

24 VCCAUX: Auxiliary voltage supply (+2.5V)

120 GND: Ground

Bank 0														
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
A	GND	GND	HSWAP_EN	I/O L01P_0 VRN_0	I/O L02P_0	GND	I/O L35P_0	I/O L09P_0	I/O L38P_0	GND	I/O L17P_0	I/O L22P_0	I/O L25P_0	GND
B	GND	GND	PROG_B	I/O L01N_0 VRP_0	I/O L02N_0	I/O L04P_0	I/O L35N_0	I/O L09N_0	I/O L38N_0	I/O L12P_0	I/O L17N_0	I/O L22N_0	I/O L25N_0	I/O L28P_0
C	I/O L01N_7 VRP_7	I/O L01P_7 VRN_7	TDI	I/O VREF_0	VCCO_0	I/O L04N_0	I/O L06P_0	I/O L08P_0	VCCO_0	I/O L12N_0	I/O L16P_0	I/O L21P_0	VCCO_0	I/O L28N_0
D	I/O L03N_7 VRP_7	I/O L03P_7	I/O L02N_7	I/O L02P_7	I/O L03N_0	VCCAUX	I/O L06N_0	I/O L08N_0	I/O L37P_0	VCCAUX	I/O L16N_0	I/O L21N_0	I/O	VCCAUX
E	I/O L04N_7	I/O L04P_7	VCCO_7	I/O L05P_7	GND	I/O L03P_0	VCCO_0	I/O L07P_0	I/O L37N_0	GND	I/O L15P_0	I/O L20P_0	I/O L24P_0	GND
F	GND	I/O L06N_7	I/O L06P_7	VCCAUX	I/O L05N_7	I/O L05N_0	I/O L05P_0 VREF_0	I/O L07N_0	I/O VREF_0	I/O L11P_0	I/O L15N_0	I/O L20N_0	I/O L24N_0	I/O L27P_0
G	I/O L08N_7	I/O L08P_7	I/O L07N_7	I/O VCCO_7	I/O L09P_7	I/O L36N_0	I/O L09P_0	I/O	VCCO_0	I/O L11N_0	I/O L14P_0	I/O L19P_0	VCCO_0	I/O L27N_0
H	I/O L13N_7	I/O L13P_7	I/O L11N_7	I/O L11P_7	I/O L10N_7	I/O L10P_7 VREF_7	I/O L09N_7	I/O L36P_0	I/O L10P_0	GND	I/O L14N_0	I/O L19N_0	I/O L23P_0	GND
J	I/O L15N_7	I/O L15P_7	VCCO_7	I/O L14N_7	I/O L14P_7	I/O	VCCO_0	I/O L16P_7 VREF_7	I/O L10N_0	I/O L13N_0	VCCO_0	I/O L18P_0	I/O L23N_0	I/O L26P_0 VREF_0
K	GND	I/O L19N_7 VRP_7	I/O L19P_7	VCCAUX	GND	I/O L17N_7	I/O L17P_7	GND	I/O L16N_7	I/O L20P_7	I/O L13P_0	I/O L18N_0	I/O	I/O L26N_0
L	I/O L24N_7	I/O L24P_7	I/O L23N_7	I/O L23P_7	I/O L22N_7	I/O L22P_7	I/O L21N_7	I/O L21P_7	VCCO_7	I/O L20N_7	VCCINT	VCCO_0	VCCO_0	VCCO_0
M	I/O L27N_7	I/O L27P_7 VREF_7	I/O L26N_7	I/O L26P_7	I/O L49P_7	I/O L25N_7	I/O L25P_7	I/O L46N_7	I/O L46P_7	I/O L28P_7	VCCO_7	VCCINT	VCCINT	VCCINT
N	I/O L31N_7	I/O L31P_7	VCCO_7	I/O L50N_7	I/O L50P_7	I/O L49N_7	VCCO_7	I/O L29P_7	I/O L28N_7	VCCO_7	VCCINT	GND	GND	GND
P	GND	I/O L34N_7	I/O L34P_7	VCCAUX	GND	I/O L33N_7	I/O L33P_7	GND	I/O L32N_7	I/O L32P_7	VCCO_7	VCCINT	GND	GND
R	I/O L40N_7 VRP_7	I/O L40P_7	I/O L39P_7	I/O L39P_7	I/O L38N_7	I/O L38P_7	I/O L37N_7	I/O L37P_7 VREF_7	I/O L35N_7	I/O L35P_7	VCCINT	GND	GND	GND
T	I/O L40P_6 VRP_6	I/O L40N_6	I/O L39P_6	I/O L39N_6	I/O L38P_6	I/O L38N_6	I/O L52P_6	I/O L52N_6	I/O L37P_6	I/O L37N_6	VCCINT	GND	GND	GND
U	GND	I/O L36P_6	I/O L36N_6	VCCAUX	GND	I/O L35P_6	I/O L35N_6	GND	I/O L34P_6	I/O L34N_6 VREF_6	VCCO_6	VCCINT	GND	GND
V	I/O L33P_6	I/O L33N_6	VCCO_6	I/O L32P_6	I/O L32N_6	I/O L31P_6	VCCO_6	I/O L30P_6	I/O L30N_6	I/O L29P_6	VCCO_6	VCCINT	GND	GND
W	I/O L28P_6	I/O L28N_6	I/O L27P_6	I/O L27N_6	I/O L31N_6	I/O L26P_6	I/O L26N_6	I/O L25P_6	I/O L25N_6	I/O L29N_6	VCCO_6	VCCINT	VCCINT	VCCINT
Y	I/O L24P_6	I/O L24N_6 VREF_6	I/O L45P_6	I/O L45N_6	I/O L22P_6	I/O L22N_6	I/O L21P_6	I/O L21N_6	VCCO_6	I/O L20P_6	VCCINT	VCCO_5	VCCO_5	VCCO_5
A	GND	I/O L19P_6	I/O L19N_6	VCCAUX	GND	I/O L17P_6 VREF_6	I/O L17N_6	GND	I/O L16P_6	I/O L20N_6	I/O	I/O L22P_5	I/O L22N_5	I/O L26P_5
B	I/O L15P_6	I/O L15N_6	VCCO_6	I/O L14P_6	I/O L14N_6	I/O	VCCO_6	I/O L16N_6	I/O L08P_5	I/O	VCCO_5	I/O L17N_5	I/O L23P_5	I/O L26N_5
C	I/O L13P_6 VREF_6	I/O L13N_6	I/O L11P_6	I/O L11N_6	I/O L10P_6	I/O L10N_6	I/O L09P_6	I/O L36P_5	I/O L08N_5	GND	I/O L17P_5	I/O L18P_5	I/O L23N_5	GND
D	I/O L08P_6	I/O L08N_6	I/O L07P_6	I/O L07N_6	VCCO_6	I/O L09N_6 VREF_6	I/O L05P_5	I/O L36N_5	VCCO_5	I/O L13P_5	I/O L13N_5	I/O L18N_5	VCCO_5	I/O L30P_5
A	GND	I/O L06P_6	I/O L06N_6	VCCAUX	I/O L05P_6	I/O	I/O L05N_5	I/O L37P_5	I/O L11P_5	I/O L11N_5 VREF_5	I/O L14P_5	I/O L19P_5 VREF_5	I/O L27P_5	I/O L27N_5 VREF_5
F	I/O L04P_6	I/O L04N_6	VCCO_6	I/O L05N_6	GND	I/O L03N_5	VCCO_5	I/O L37N_5	I/O L09P_5	GND	I/O L14N_5	I/O L19N_5	I/O L24P_5	GND
G	I/O L03P_6	I/O L03N_6 VREF_6	I/O L02P_6	I/O L02N_6	I/O L03P_5	VCCAUX	I/O L06P_5	I/O L38P_5	I/O L09N_5	VCCAUX	I/O L15P_5	I/O L20P_5	I/O L24N_5	VCCAUX
H	I/O L01P_6 VRN_6	I/O L01N_6 VRP_6	M1	I/O VREF_5	VCCO_5	I/O L04P_5	I/O L06N_5	I/O L38N_5	VCCO_5	I/O L12P_5	I/O L15N_5	I/O L20N_5	VCCO_5	I/O L28P_5 D7
J	GND	GND	M0	I/O L01P_5 CS_B	I/O L02P_5	I/O L04N_5	I/O L07P_5	I/O L35P_5 VRN_5	I/O L12N_5	I/O L16P_5	I/O L21P_5	I/O L25P_5	I/O L28N_5 D6	I/O L32N_5 GCLK3
K	GND	GND	M2	I/O L01N_5 RDWR_B	I/O L02N_5	GND	I/O L35N_5	I/O L07N_5	I/O L10N_5 VRP_5	GND	I/O L16N_5	I/O L21N_5	I/O L25N_5	GND

Figure 55: FG900 Package Footprint (Top View)

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Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
4	IO_L21N_4	IO_L21N_4	AL21	I/O
4	IO_L21P_4	IO_L21P_4	AM21	I/O
4	IO_L22N_4/VREF_4	IO_L22N_4/VREF_4	AN21	VREF
4	IO_L22P_4	IO_L22P_4	AP21	I/O
4	IO_L23N_4	IO_L23N_4	AE20	I/O
4	IO_L23P_4	IO_L23P_4	AF20	I/O
4	IO_L24N_4	IO_L24N_4	AH20	I/O
4	IO_L24P_4	IO_L24P_4	AJ20	I/O
4	IO_L25N_4	IO_L25N_4	AL20	I/O
4	IO_L25P_4	IO_L25P_4	AM20	I/O
4	IO_L26N_4	IO_L26N_4	AN20	I/O
4	IO_L26P_4/VREF_4	IO_L26P_4/VREF_4	AP20	VREF
4	IO_L27N_4/DIN/D0	IO_L27N_4/DIN/D0	AH19	DUAL
4	IO_L27P_4/D1	IO_L27P_4/D1	AJ19	DUAL
4	IO_L28N_4	IO_L28N_4	AM19	I/O
4	IO_L28P_4	IO_L28P_4	AN19	I/O
4	IO_L29N_4	IO_L29N_4	AF18	I/O
4	IO_L29P_4	IO_L29P_4	AG18	I/O
4	IO_L30N_4/D2	IO_L30N_4/D2	AH18	DUAL
4	IO_L30P_4/D3	IO_L30P_4/D3	AJ18	DUAL
4	IO_L31N_4/INIT_B	IO_L31N_4/INIT_B	AL18	DUAL
4	IO_L31P_4/DOOUT/BUSY	IO_L31P_4/DOOUT/BUSY	AM18	DUAL
4	IO_L32N_4/GCLK1	IO_L32N_4/GCLK1	AN18	GCLK
4	IO_L32P_4/GCLK0	IO_L32P_4/GCLK0	AP18	GCLK
4	IO_L33N_4	IO_L33N_4	AL29	I/O
4	IO_L33P_4	IO_L33P_4	AM29	I/O
4	IO_L34N_4	IO_L34N_4	AN29	I/O
4	IO_L34P_4	IO_L34P_4	AP29	I/O
4	IO_L35N_4	IO_L35N_4	AJ28	I/O
4	IO_L35P_4	IO_L35P_4	AK28	I/O
4	N.C. (◆)	IO_L36N_4	AL28	I/O
4	N.C. (◆)	IO_L36P_4	AM28	I/O
4	N.C. (◆)	IO_L37N_4	AN28	I/O
4	N.C. (◆)	IO_L37P_4	AP28	I/O
4	IO_L38N_4	IO_L38N_4	AK27	I/O
4	IO_L38P_4	IO_L38P_4	AL27	I/O
4	N.C. (◆)	IO_L39N_4	AH24	I/O
4	N.C. (◆)	IO_L39P_4	AJ24	I/O
4	N.C. (◆)	IO_L40N_4	AN24	I/O
4	N.C. (◆)	IO_L40P_4	AP24	I/O

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
4	VCCO_4	VCCO_4	AC19	VCCO
4	VCCO_4	VCCO_4	AC20	VCCO
4	VCCO_4	VCCO_4	AC21	VCCO
4	VCCO_4	VCCO_4	AC22	VCCO
4	VCCO_4	VCCO_4	AG20	VCCO
4	VCCO_4	VCCO_4	AG24	VCCO
4	VCCO_4	VCCO_4	AH27	VCCO
4	VCCO_4	VCCO_4	AJ22	VCCO
4	VCCO_4	VCCO_4	AL19	VCCO
4	VCCO_4	VCCO_4	AL24	VCCO
4	VCCO_4	VCCO_4	AM27	VCCO
4	VCCO_4	VCCO_4	AM31	VCCO
4	VCCO_4	VCCO_4	AN22	VCCO
5	IO	IO	AD11	I/O
5	N.C. (◆)	IO	AD12	I/O
5	IO	IO	AD14	I/O
5	IO	IO	AD15	I/O
5	IO	IO	AD16	I/O
5	IO	IO	AD17	I/O
5	IO	IO	AE14	I/O
5	IO	IO	AE16	I/O
5	N.C. (◆)	IO	AF9	I/O
5	IO	IO	AG9	I/O
5	IO	IO	AG12	I/O
5	IO	IO	AJ6	I/O
5	IO	IO	AJ17	I/O
5	IO	IO	AK10	I/O
5	IO	IO	AK14	I/O
5	IO	IO	AM12	I/O
5	IO	IO	AN9	I/O
5	IO/VREF_5	IO/VREF_5	AJ8	VREF
5	IO/VREF_5	IO/VREF_5	AL5	VREF
5	IO/VREF_5	IO/VREF_5	AP17	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	AP3	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	AN3	DUAL
5	IO_L02N_5	IO_L02N_5	AP4	I/O
5	IO_L02P_5	IO_L02P_5	AN4	I/O
5	IO_L03N_5	IO_L03N_5	AN5	I/O
5	IO_L03P_5	IO_L03P_5	AM5	I/O
5	IO_L04N_5	IO_L04N_5	AM6	I/O

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
5	VCCO_5	VCCO_5	AJ13	VCCO
5	VCCO_5	VCCO_5	AL11	VCCO
5	VCCO_5	VCCO_5	AL16	VCCO
5	VCCO_5	VCCO_5	AM4	VCCO
5	VCCO_5	VCCO_5	AM8	VCCO
5	VCCO_5	VCCO_5	AN13	VCCO
6	IO	IO	AH1	I/O
6	IO	IO	AH2	I/O
6	IO	IO	V9	I/O
6	IO	IO	V10	I/O
6	IO_L01N_6/VRP_6	IO_L01N_6/VRP_6	AM2	DCI
6	IO_L01P_6/VRN_6	IO_L01P_6/VRN_6	AM1	DCI
6	IO_L02N_6	IO_L02N_6	AL2	I/O
6	IO_L02P_6	IO_L02P_6	AL1	I/O
6	IO_L03N_6/VREF_6	IO_L03N_6/VREF_6	AK3	VREF
6	IO_L03P_6	IO_L03P_6	AK2	I/O
6	IO_L04N_6	IO_L04N_6	AJ4	I/O
6	IO_L04P_6	IO_L04P_6	AJ3	I/O
6	IO_L05N_6	IO_L05N_6	AJ2	I/O
6	IO_L05P_6	IO_L05P_6	AJ1	I/O
6	IO_L06N_6	IO_L06N_6	AH6	I/O
6	IO_L06P_6	IO_L06P_6	AH5	I/O
6	IO_L07N_6	IO_L07N_6	AG6	I/O
6	IO_L07P_6	IO_L07P_6	AG5	I/O
6	IO_L08N_6	IO_L08N_6	AG2	I/O
6	IO_L08P_6	IO_L08P_6	AG1	I/O
6	IO_L09N_6/VREF_6	IO_L09N_6/VREF_6	AF7	VREF
6	IO_L09P_6	IO_L09P_6	AF6	I/O
6	IO_L10N_6	IO_L10N_6	AG4	I/O
6	IO_L10P_6	IO_L10P_6	AF4	I/O
6	IO_L11N_6	IO_L11N_6	AF3	I/O
6	IO_L11P_6	IO_L11P_6	AF2	I/O
6	IO_L12N_6	IO_L12N_6	AF8	I/O
6	IO_L12P_6	IO_L12P_6	AE9	I/O
6	IO_L13N_6	IO_L13N_6	AE8	I/O
6	IO_L13P_6/VREF_6	IO_L13P_6/VREF_6	AE7	VREF
6	IO_L14N_6	IO_L14N_6	AE6	I/O
6	IO_L14P_6	IO_L14P_6	AE5	I/O
6	IO_L15N_6	IO_L15N_6	AE4	I/O
6	IO_L15P_6	IO_L15P_6	AE3	I/O

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
7	IO_L45P_7	IO_L45P_7	M2	I/O
7	IO_L46N_7	IO_L46N_7	N7	I/O
7	IO_L46P_7	IO_L46P_7	N8	I/O
7	N.C. (◆)	IO_L47N_7	P9	I/O
7	N.C. (◆)	IO_L47P_7	P10	I/O
7	IO_L49N_7	IO_L49N_7	P1	I/O
7	IO_L49P_7	IO_L49P_7	P2	I/O
7	IO_L50N_7	IO_L50N_7	R10	I/O
7	IO_L50P_7	IO_L50P_7	R11	I/O
7	N.C. (◆)	IO_L51N_7	U11	I/O
7	N.C. (◆)	IO_L51P_7	T11	I/O
7	VCCO_7	VCCO_7	D3	VCCO
7	VCCO_7	VCCO_7	H3	VCCO
7	VCCO_7	VCCO_7	H7	VCCO
7	VCCO_7	VCCO_7	L4	VCCO
7	VCCO_7	VCCO_7	L8	VCCO
7	VCCO_7	VCCO_7	N12	VCCO
7	VCCO_7	VCCO_7	N2	VCCO
7	VCCO_7	VCCO_7	N6	VCCO
7	VCCO_7	VCCO_7	P12	VCCO
7	VCCO_7	VCCO_7	R12	VCCO
7	VCCO_7	VCCO_7	R8	VCCO
7	VCCO_7	VCCO_7	T12	VCCO
7	VCCO_7	VCCO_7	T4	VCCO
N/A	GND	GND	A1	GND
N/A	GND	GND	A13	GND
N/A	GND	GND	A16	GND
N/A	GND	GND	A19	GND
N/A	GND	GND	A2	GND
N/A	GND	GND	A22	GND
N/A	GND	GND	A26	GND
N/A	GND	GND	A30	GND
N/A	GND	GND	A33	GND
N/A	GND	GND	A34	GND
N/A	GND	GND	A5	GND
N/A	GND	GND	A9	GND
N/A	GND	GND	AA14	GND
N/A	GND	GND	AA15	GND
N/A	GND	GND	AA16	GND
N/A	GND	GND	AA17	GND